TOSHIBA BI-CMOS INTEGRATED CIRCUIT SILICON MONOLITHIC

TB1274BFG

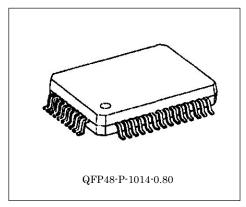
LUMINANCE, CHROMA AND SYNCHRONIZING SIGNALS PROCESSOR IC FOR PAL / NTSC / SECAM COLOR TV

TB1274BFG integrates luminance, chroma and synchronizing signals processing circuits for PAL / NTSC / SECAM color TV system.

TB1274BFG incorporates high performance picture quality compensation circuits in luminance section, an automatic PAL / NTSC / SECAM discrimination and decode circuits in chroma section, and an automatic 50 / 60 Hz discrimination circuit in synchronizing section.

Besides a crystal oscillator generates 4.43MHz, 3.58MHz and M/N-PAL clock signals internally for color demodulation. A horizontal PLL circuit is also built in this IC.

PAL / SECAM demodulation circuits which are adjustment-free circuits incorporates a 1H DL circuit inside for operating the base band signal processing system.



Weight: 0.83 g (Typ.)

Also, TB1274BFG makes it possible to set and to control various functions through the built-in I^2C BUS line

FEATURES

LUMINANCE SECTION

- Built-in chroma trap filter
- Y delay line
- Sharpness control
- Sub-Contrast control (-/+ 2dB)
- Black set-up

CHROMA SECTION

- Built-in 1H delay circuit (PAL / SECAM base band demodulation system)
- One crystal color demodulation circuit (4.43MHz, 3.58MHz, M/N-PAL)
- Automatic system discrimination system and forced system mode
- 1H delay line also serves as comb filter in NTSC demodulation
- Built-in band-pass and take-off filter, SECAM bell filter
- Sub-Color control (-/+2dB)

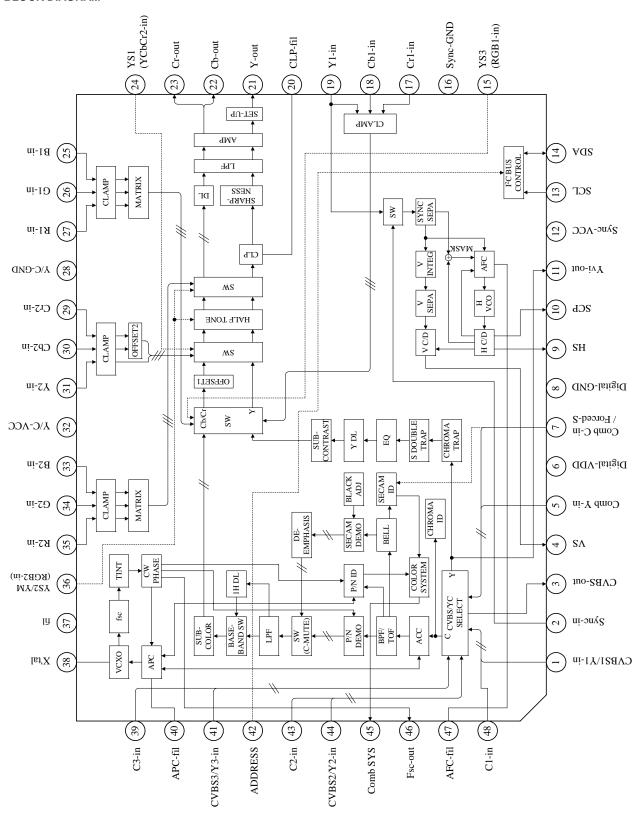
SYNCHRONIZING SECTION

- Built-in horizontal VCO resonator
- Adjustment-free horizontal and vertical oscillation by count-down circuit
- Automatic vertical frequency discrimination circuit
- Noise detection circuit

OTHERS

- Y/C out level control
- 4-channels inputs switching
- 2-input circuit for RGB
- 2-input circuit for Y/Cb/Cr
- Y/Cb/Cr outputs
- Cb/Cr offset adjustment
- Built-in pre filters for A/D converter

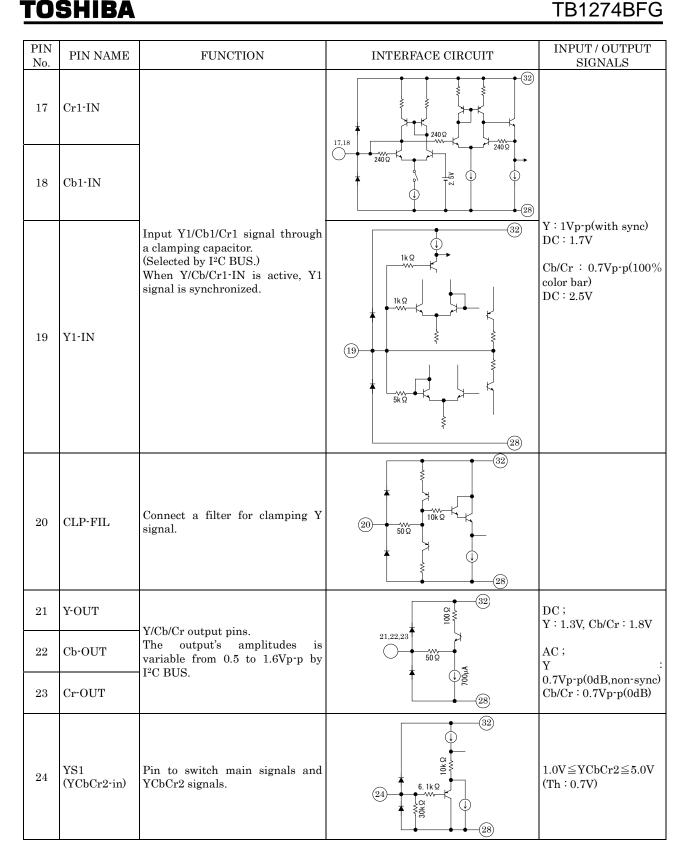
BLOCK DIAGRAM



TERMINAL DESCRIPTIONS (YC-VCC/SYNC-VCC/D-VDD=5V and Ta=25°C, unless otherwise specified) INPUT / OUTPUT PIN NAME **FUNCTION** INTERFACE CIRCUIT SIGNALS No. -(32) CVBS: 1Vp-p Input CVBS1/Y1 signal through a CVBS1/Y1-IN Y: 1Vp-p(with sync) 1 250 Ω clamping capacitor. DC: 1.8V 1kΩ 1Vp-p (with sync) (2) SYNC-IN 2 Input signal to synchronize. DC: 1.7V 2Vp-p(with sync) CVBS-OUT CVBS or Y+C signal output pin. DC: 0.6V 700 ¼ A -(12)Hi Output pin vertical Low synchronizing signal. VS 4 -γνν 50 Ω Minimum pull-up resister is $4.7V \le Hi \le 5.2V$ $6.8 \mathrm{k}\,\Omega$. $0V \le Low \le 0.8V$ (32)Input luminance signal from 1Vp-p(with sync) COMB Y-IN (5)Comb filter through a clamping 250 Ω DC: 1.8V capacitor. (28) Power supply for pin D-VDD 6 DC 5V DDS/BUS/V-CD/H-CD sections. Input chroma signal from Comb filter through clamping a 0.3Vp-p(Burst) capacitor. When this pin is 250 Q DC: 2.4V Forced-S COMB C-IN connected to Vcc, color killer is 40k S 7 / FORCED-S OFF and SECAM ID is ON $4.0V \le Forced-S \le 5.0V$ forcibly. (Forced SECAM mode) (Th: 3.5V) Refer **FUNCTION** to DESCRIPTION.

PIN	PIN NAME	FUNCTION	INTERFACE CIRCUIT	INPUT / OUTPUT
No. 8	D-GND	GND pin for	-	SIGNALS
9	HS	DDS/BUS/V-CD/H-CD sections. Output pin of horizontal synchronizing signal. Minimum pull-down resister is $2.7 k \Omega$.	9 500 (12)	
10	SCP	Sand Castle Pulse output pin. The clamping pulse and the horizontal blanking pulse are outputted.	10 12 C M 16	$CP \\ H-BLK \\ Low \\ 3.6V \le CP \le 4.4V \\ 1.6V \le H-BLK \le 2.4V \\ 0.0V \le Low \le 0.8V \\ with pull-down \\ resister (7.5k \Omega)$
11	Yvi-OUT	Output pin to synchronize inputs. Y signal from video-SW is outputted.	(12) (12) (13) (14) (15) (16)	1Vp-p(with sync) DC: 2.1V
12	SYNC-VCC	Power supply pin for liner SYNC/HVCO sections.	_	DC 5V
13	SCL	SCL pin for I ² CBUS.	13 3k Ω 100k Ω	
14	SDA	SDA pin for I ² CBUS.	14 50Ω 3kΩ 1 SDA SDA SDA 88	
15	YS3 (RGB1-in)	Pin to switch main signals and RGB1 signals. If the voltage of this pin is HI and the RGB1-ENB data is "enable" via I ² C BUS, RGB1-IN is selected. And its status is responded to the Read Bus data.	32) 6kΩ CG W 28	1.0V≦RGB1≦5.0V (Th:0.7V)
16	SYNC-GND	GND pin for liner SYNC/HVCO sections.	_	

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PIN No.	PIN NAME	FUNCTION	INTERFACE CIRCUIT	INPUT / OUTPUT SIGNALS	
25	B1-IN			ычнаць	
26	G1-IN	Input RGB1 signal through a clamping capacitor.(Selected by YS3 and I ² C BUS.)	25,26,27	0.7Vp-p DC: 2.5V	
27	R1-IN		\$\\ \frac{1}{\cdot \cdot		
28	Y/C-GND	GND pin for Y/C/Text/Video-SW/1HDL sections.	_		
29	Cr2-IN		29,30		
30	Cb2-IN	Input Y2/Cb2/Cr2 signal through	Z70Q DAC OPPSET 1	Y: 1Vp-p(with sync) DC: 1.7V	
31	Y2-IN	a clamping capacitor. (Selected by YS1.)	31 240 \(\text{240 } \text{240 } \text{240 } \text{240 } \text{28}	Cb/Cr : 0.7Vp-p(100% color bar) DC : 2.5V	
32	Y/C-VCC	Power supply pin for Y/C/Text/ Video-SW/1HDL sections.	-	DC 5V	
33	B2-IN		332		
34	G2-IN	Input RGB2 signal through a clamping capacitor. (Selected by YS2.)	33,34,35	0.7Vp-p DC: 2.5V	
35	R2-IN		\$\frac{1}{\sqrt{2}}\$		
36	YS2/YM (RGB2-in)	Pin to switch main signals and RGB2 inputs. Half-tone ON/OFF SW is also included. Half tone gain is selected by I ² C BUS.	32 32 36 36 36 36 38 38 38 38 38 38 38 38 38 38	$1.0V \le YM \le 1.5V$ $2.5V \le RGB2 \le 5.0V$ (Th1 : 0.7V, Th2 : 2.0V)	

PIN No.	PIN NAME	FUNCTION	INTERFACE CIRCUIT	INPUT / OUTPUT SIGNALS
37	FIL	Connect this terminal to Y/C VCC.	-	-
38	X'TAL	Pin to connect a 16.2MHz crystal. Recommended crystal: NR-18 NT162020A, made by NIHON DENPA KOGYO CO, LTD.	$\begin{array}{c c} & & & & & & & \\ & & & & & & \\ \hline & & & &$	16.2MHz wave
39	C3-IN	Input C3 signal through a clamping capacitor.	332 V T OS V	0.3Vp-p(Burst) DC: 1.6V
40	APC-FIL	Connect APC filer.	40 110k \(\text{200} \(\text{2} \) 10k \(2	
41	CVBS3/Y3-IN	Input CVBS3/Y3 signal through a clamping capacitor.	32 32 41 250Ω 41 41 250Ω 41 41 41 41 41 41 41 41 41 41	CVBS: 1Vp-p Y: 1Vp-p(with sync) DC: 1.8V
42	ADDRESS	Slave address setting pin. Select slave address. When this pin is open, $8A/8B_H$ is selected. W 88_H $8A_H$ $8E_H$ R 89_H $8B_H$ $8F_H$	(6) (6) (7) (8) (8) (8) (8) (8)	$\begin{array}{c} 88/89_{H}\!\leq\!1.3V\\ 3.9V\!\leq\!8E/8F_{H}\\ (Th1\ :\ 1.5V,\ Th2\ :\ 3.2V) \end{array}$
43	C2-IN	Input C2 signal through a clamping capacitor.	43 250Ω CS WOP 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	0.3Vp-p(Burst) DC: 1.6V

PIN No.	PIN NAME	FUNCTION	INTERFACE CIRCUIT	INPUT / OUTPUT SIGNALS
44	CVBS2/Y2-IN	Input CVBS2/Y2 signal through a clamping capacitor.	32) 32) 44) 250Ω 44) 250Ω 44) 250Ω 44) 250Ω	CVBS: 1Vp-p Y: 1Vp-p(with sync) DC: 1.8V
45	COMB SYS	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	32 C3 N05 28	5V High OV
46	Fsc-OUT	Sub-carrier output pin. Refer to FUNCTION DESCRIPTION.	32 46 100Ω ΨποΖΖ 28	AC: 0.84Vp-p DC: as blow fig. (3.1V) High Low (2.1V)
47	AFC-FIL	Connect AFC filter.	(12) (16)	
48	C1-IN	Input C1 signal through a clamping capacitor.	(48) 2500 V MOS V	0.3Vp-p(Burst) DC: 1.6V

TOSHIBA TB1274BFG

WRITE MODE

SLAVE ADDRESS: 88_H / 8A_H / 8E_H

SUB	MSB							LSB	PRESET		
ADDRESS	D7	D6	D5	D4	D3	D2	D1	D0			
80	P/N ID	P/N GW			TI	NT			0010 0000		
81		SUB-CO	NTRAST			SUB-C	COLOR		1000 1000		
82		SHARPN	ESS GAIN		SHARPN	NESS EQ	SHARP	${ m NESS}~{ m f}_0$	1000 0000		
83	0	0			Y-OUT	LEVEL			0010 0000		
84	0	0			C-OUT	LEVEL			0010 0000		
85	LPF	S-D TRAP	C-TRAP SW	FILTER SW	BP	F Q	BP	$F f_0$	0000 0000		
86	N-COMB	-COMB Y-DL				COLOR SYSTEM			0010 1000		
87	Cb/Cr-MUTE	HALF TONE	RGB S	ELECT		VIDEO SELECT					
88		Cb OF	FSET1		Cr OFFSET1				1000 1000		
89		Cb OF	FSET2		$\operatorname{Cr}\operatorname{OFFSET2}$				1000 1000		
8A	MVM	AFC	GAIN	V C/D	MODE		V-FREQ		0000 0000		
8B		S B-Y	/ ADJ			S R-Y	/ ADJ		1000 1000		
8C	S-INHBT	S ID	S GP		S V-ID	$\operatorname{BELL} \mathbf{f}_0$	BELI	/HPF	0000 0000		
8D	AUTO-SW	0	0	0	HS-PH	0	SETUP-SW	RGB1 ENB	1000 0000		
8E	0	VP-PH	1	0	0	0	0	0	0010 0000		
8F			TEST MODE								

READ MODE

SLAVE ADDRESS: 89_H / 8B_H / 8F_H

 ENT HIBBITAGE CONT CONT CONT								
SUB	MSB							LSB
ADDRESS	D7	D6	D5	D4	D3	D2	D1	D0
00	POR	COLOR	SYSTEM	X'T	ΆL	N-I	ET	H-LOCK
01	V-FREQ	V-STD	C ID	V-SIG	V15	*	*	1

Note) *; don't care

BUS CONTROL FUNCTION

WRITE MODE

 $\underline{SLAVE\ ADDRESS:88_{H}\ /\ 8A_{H}\ /\ 8E_{H}}$

ITEM / Number of bits	FUNCTION	VARIABLE RANGE	PRESET
TINT / ⑥	TINT adjustment for NTSC	00H: -33deg∼3F H: +33deg (1LSB=1.1deg)	0deg
P/N GW / ①	PAL/NTSC gate width	$0: 2.0 \mu \mathrm{s}, 1: 3.2 \mu \mathrm{s}$	$2.0\mu~\mathrm{s}$
P/N ID / ①	PAL/NTSC sensitivity SW	0: Normal, 1: Low	Normal
SUB-COLOR / ④	Sub-color control	0 H : -2dB ∼ F H : 2dB	0dB
SUB-CONTRAST / ④	Sub-contrast control	0 H : -2dB ∼ F H : 2dB	0dB
SHARPNESS f ₀ / ②	Sharpness center frequency changing	00: 2.5MHz, 01: 3.2MHz 10: 4.0MHz, 11: OFF	2.5MHz
SHARPNESS EQ / ②	Sharpness equalizer characteristic (Evaluation with 2T-pulse)	00:1:1.2, 01:1:1 10:1.2:1, 11:1.4:1	1:1.2
SHARPNESS GAIN /	Sharpness gain control	0 H : -6dB ∼ F H : 6dB	0dB
Y-OUT LEVEL / ⑥	Y output level control (pin 21)	00 H : 0.5 ∼ 3F H : 1.6Vp-p	1.05Vp-p
C-OUT LEVEL / ⑥	Cb/Cr output level control (pin 22/23)	00 H : 0.5 ∼ 3F H : 1.6Vp-p	1.05Vp-p
BPF f ₀ / ②	BPF/TOF fo adjustment	00:-400kHz, 01:+0kHz, 10:+400kHz, 11:OFF(by-pass)	-400kHz
BPF Q / ②	BPF/TOF Q adjustment	00: 1.0, 01: 1.5 10: 2.0, 11: 2.5	1.0
FILTER SW / ①	BPF/TOF switch	0:BPF, 1:TOF	BPF
C-TRAP SW / ①	Chroma trap switch This function is controlled automatically by setting of "VIDEO SELECT" and "Y/C-AUTO". Refer to FUNCTION DESCRIPTION.	0:ON, 1:OFF	ON
S-D TRAP / ①	SECAM double trap switch This function is controlled automatically by setting of "VIDEO SELECT" and "Y/C-AUTO". Refer to FUNCTION DESCRIPTION.	0: OFF, 1: ON	OFF
LPF/①	Y/Cb/Cr LPF switch	0:ON, 1:OFF(by-pass)	ON
COLOR SYSTEM / ③	Color system switching Europe automatic mode; 4.43PAL, 4.43NTSC, 3.58NTSC, SECAM South America automatic mode; 3.58NTSC, M-PAL, N-PAL Refer to FUNCTION DESCRIPTION.	000: Europe automatic 001: South America automatic 010: 3.58NTSC 011: 4.43NTSC 100: 4.43PAL 101: SECAM 110: M-PAL, 111: N-PAL	Europe automatic
Y-DL / ④	Y-DL time adjustment (1LSB=40ns) Refer to FUNCTION DESCRIPTION.	$0000: 120 \sim 1010: 520 \text{ns}$ $1011 \sim 1111: \text{don't use}$	320ns

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ITEM / Number of bits	FUNCTION	VARIABLE RANGE	PRESET
N-COMB / ①	1H addition switch, when NTCS.	0:OFF, 1:ADD	OFF
VIDEO SELECT / ④	Selection of input video signals	Refer to FUNCTION DESCRIPTION.	0000
RGB SELECT / ②	Selection of input sources. Refer to FUNCTION DESCRIPTION.	00 : Main, 01 : YCbCr1 10 : RGB1, 11 : don't use	Main
HALF TONE / ①	Half tone gain switch	0:-10dB, 1:-6dB	-10dB
Cb/Cr-MUTE / ①	Cb/Cr output mute switch	0: OFF, 1: ON	OFF
Cb/Cr OFFSET1 / ④/④	Cb/Cr offset adjustment (main route)	0 H:-12 ∼ F H:+10.5mV	0mV
Cb/Cr OFFSET2 / ④/④	Cb/Cr offset adjustment (YCbCr2 input)	0 H:-12 ∼ F H:+10.5mV	0mV
V-FREQ / ③	V count down frequency switch. Automatic mode 1; 50/60Hz automatic distinction. At no-signal, the last statement is kept. Right after power-on, 50Hz mode is run. Automatic mode 2; 50/60Hz automatic distinction. And 50Hz mode is run at no-signal. Refer to FUNCTION DESCRIPTION.	100 : Forced 312.5H (AFC free-run), 101 : Forced 262.5H (AFC free-run), 110 : Forced 313H (AFC free-run), 111 : Forced 263H (AFC free-run)	Automatic mode 1
V C/D MODE / ②	V count down judge switch. Refer to FUNCTION DESCRIPTION.	00:Normal 1, 01: Teletext, 10: Fast, 11: Normal 2 note) Normal 1: One time detection Normal 2: Continuously detection	Normal 1
AFC SENS / ②	AFC sensitivity switch	00:+6dB, 01:0dB, 10:-6dB, 11:-17dB	+6dB (data : 00)
MVM / ①	Macrovision Mask + AFC Mask	0 : Narrow, 1 : Always masked	Narrow
S R-Y ADJ / ④	SECAM R-Y black adjustment	0 H:-10 ∼ F H:8.8mV	0mV
S B-Y ADJ / ④	SECAM B-Y black adjustment	0 H:-10 ∼ F H:8.8mV	0mV
BELL/HPF/2	SECAM bell/HPF switching. Or the high frequency side on SECAM bell filter is boosted. Refer to FUNCTION DESCRIPTION.		Bell
BELL f ₀ / ①	BELL f ₀ adjustment	0 : Normal, 1 : +15kHz	Normal
S V-ID SW / ①	SECAM V-ID switch	0: OFF, 1: ON	OFF
S GP / ②	SECAM gate position adjustment (Its width is same)	00 : Normal, $01 : 0.4 \mu$ s delay, $10 : Normal$, $11 : 0.4 \mu$ s forward	Normal
SID/①	SECAM sensitivity switch	0: Normal, 1: Low	Normal
S-INHBT / ①	SECAM inhibition switch	0: Normal, 1: Inhibited	Normal
RGB1 ENB / ①	Enable YS3 to switch to RGB1-IN. Refer to FUNCTION DESCRIPTION.	0 : Disable, 1 : Enable	Disable

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ITEM / Number of bits	FUNCTION	VARIABLE RANGE	PRESET
AUTO SW / ①	Auto Video select mode SW Select automatically for CVBS, Y/C and Comb mode by setting of "AUTO-SW" and "VIDEO SELECT". And also select automatically for C-Trap and S-D Trap. Refer to FUNCTION DESCRIPTION.	0 : Auto Y/C select mode 1 : Auto Comb select mode	Manual Select
VP-PH / ①	Switching for VP output phase	0:+0.75H, 1:+0.6875H	+0.75H
SETUP-SW / ①	Y black level set-up	0: Normal, 1: Set-up	Normal
HS-PH / ①	HS Output phase switch	0 : H·Sync(4.7 μ s), 1 : GP(3.2 μ s)	H-Sync
TEST MODE / ®	Factory test mode. Set all zero.	_	$00_{\rm H}$

READ MODE

SLAVE ADDRESS : $89_{\rm H}$ / $8B_{\rm H}$ / $8F_{\rm H}$

ITEM / Number of bits	FUNCTION	VARIABLE RANGE
H-LOCK / ①	H. Lock detection	0: Un-lock, 1: Lock
N-DET / ②	Noise judgment	00: SN > 40dB, 01: 10dB > SN, 10: 40dB > SN > 20dB, 11: 20dB > SN > 10dB
X'TAL/ ②	Crystal mode judgment	00: 4.433619MHz(PAL) 01: 3.579545MHz(NTSC) 10: 3.575611MHz(M-PAL) 11: 3.582056MHz(N-PAL)
COLOR SYSTEM / ②	Color system judgment	00 : B/W, 01 : PAL 10 : NTSC, 11 : SECAM
POR / ①	Power On Reset	0: Normal, 1: Resistor preset
V15 / ①	Status of pin 15 voltage Refer to FUNCTION DESCRIPTION.	0: Low, 1: High
V-SIG / ①	Internal V. pulse detection for V. lock	0: Existing, 1: Not existing
C ID / ①	Input signal condition (Detection of burst signal on C-IN pins) Refer to FUNCTION DESCRIPTION.	0 : Not detected (CVBS), 1 : Detected (Y/C)
V-STD / ①	Decision on the standard of the vertical frequency. When no-signal, 1: STD is responded.	0: Non-STD, 1: STD
V-FREQ / ①	Vertical frequency judgment. Right after power-on, 0: 50Hz is responded. At no-signal, the last statement is kept.	
SA 01 D0 / ①	The bit for product ident	0:TB1239**, 1:TB1274**

I²C BUS START-UP PROCEDURE

Just after power-on, TB1274BFG starts tuning automatically. Initially, I^2C -BUS decoder works, and then H-VCO alignment circuit works. The following figure describes the start-up status. While Vcc is lower than 3.4V, Power-On-Reset flag indicates 1. To make TB1274BFG functioning properly, verify that POR bit is 0 by reading the I^2C BUS status data before writing data. POR is released by reading status data. Please refer the following figure and optimize the software on the set.

- 1. Power on the device.
- 2. Read the I²C BUS status bytes until POR bit indicates 0.
- 3. Write all bytes.

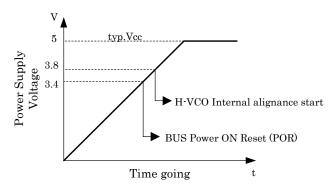


Fig. Start-up status in the IC

DATA TRANSFER FORMAT VIA I²C BUS

Slave address: select slave address for setting voltage of pin 42.

Pin42-GND(<1.3V): 88H

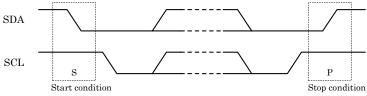
A6	A5	A4	A3	A2	A1	A0	W/R
1	0	0	0	1	0	0	0/1

Pın42–Open : 8AH										
A6	A5	A4	A3	A2	A1	A0	W/R			
1	0	0	0	1	0	1	0 / 1			

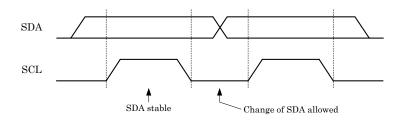
Pin42-VDD(>3.9V): 8EH

A6	A5	A4	A3	A2	A1	A0	W/R
1	0	0	0	1	1	1	0/1

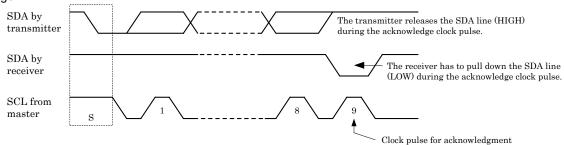
Start and stop condition



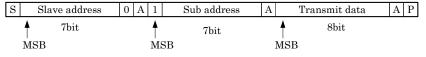
Bit transfer



Acknowledge



Data transmit format 1

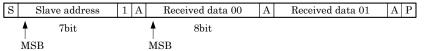


Data transmit format 2

S Slave address	0	Α	1	Sub ac	ldres	s	A	Transr	nit da	ata 1	A		(
				(1	S	ub ac	ldress	A	Trans	smi	t data n		A	P



Data receive format

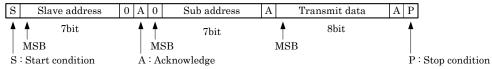


At the moment of the first acknowledge, the master transmitter becomes a master receiver and the slave receiver becomes a slave transmitter. This acknowledge is still generated by the slave.

The Stop condition is generated by the master.

Option Data transmit format

Automatic increment mode 1



Automatic increment mode 2

\mathbf{S}	Slave address	0 /	0	Sub address	A	Transmit data 1	 Transmit data n	A	Р
	7bit			7bit		8bit	8bit	-	

In this transmission method, data is set on automatically incremented sub-address from the specified sub-address.

I²C BUS Conditions

Characteristics	Symbol	Min	Тур.	Max	Unit
Low level input voltage	V_{IL}	0	_	1.3	V
High level input voltage	V _{IH}	3.8	_	Vcc	V
Low level output voltage at 3 mA sink current	V _{OL1}	0	_	0.4	V
Input current each I/O pin with an input voltage between 0.1 VDD and 0.9 VDD	Ii	-10	_	10	μΑ
Capacitance for each I/O pin	C _i	_	_	10	pF
SCL clock frequency	f _{SCL}	0	_	100	kHz
Hold time START condition	t _{HD;STA}	4.0	_	_	μS
Low period of SCL clock	t _{LOW}	4.7	_	_	μS
High period of SCL clock	tHIGH	4.0	_	_	μS
Set-up time for a repeated START condition	t _{SU;STA}	4.7	_	_	μS
Data hold time	t _{HD;DAT}	50	_	_	ns
Data set-up time	t _{SU;DAT}	250	_	_	ns
Set-up time for STOP condition	t _{SU;STO}	4.0	_	_	μS
Bus free time between a STOP and START condition	tBUF	4.7	_	_	μS

FUNCTION DESCRIPTION

VIDEO SELECT, AUTO-SW 1) "AUTO-SW" = (1) Manual select

When "AUTO-SW" is (1) Manual select, input signal is selected by the BUS as Fig. 1 and Table 1. Mainly, CVBS-OUT(pin 3) is used for the comb filter input, and Yvi-OUT(pin 11) is used for synchronization(pin 2). Besides, on chroma line from video SW to main route, the peak detection is done during the burst period. The result is responded to the Read BUS data, C ID.

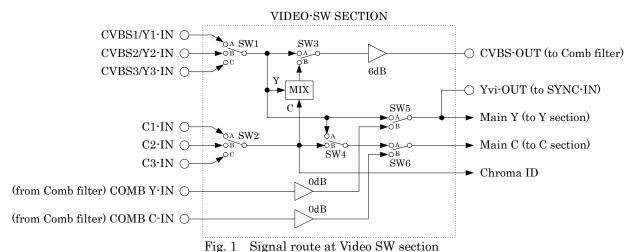


Table 1	Selected	input and	pin 3/11	output from	Video SW	section '
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BUS			SW 1	node	;		To Y/C	section	Output fr	om V-SW	
DATA	1	2	3	4	5	6	Main Y	Main C	CVBS-out	Yvi-out	
0000	Α		Α	Α	Α	Α	CVBS1	CVBS1	CVBS1	CVBS1	
0001	В		Α	Α	Α	Α	CVBS2	CVBS2	CVBS2	CVBS2	
0010	С		Α	Α	A	Α	CVBS3	CVBS3	CVBS3	CVBS3	
0100	Α	Α	В	В	Α	Α	Y1	C1	Y1+C1	Y1	
0101	В	В	В	В	Α	Α	Y2	C2	Y2+C2	Y2	
0110	С	С	В	В	A	Α	Y3	C3	Y3+C3	Y3	
1000	Α		Α		В	В	COMBY	COMB C	CVBS1	COMBY	
1001	В		Α		В	В	COMBY	COMB C	CVBS2	COMBY	
1010	С		Α		В	В	COMB Y	COMB C	CVBS3	COMB Y	
others	_	_	_	_	_	_	Don't use.				

2) "AUTO-SW" = (0) Auto select

Depending on this function and VIDEO SELECT, can select Auto Y/C select mode or Auto Comb select mode (Table 2). The input system chose automatically by the sate of color system detection and C-ID (Chroma ident detection). And C-TRAP and S-D TRAP selected also automatically.

Table 2 The changing Selective Mode

SA07H D3	Selective Mode	Content					
0	Auto Y/C select	Automatic input select CVBS input or Y/C input					
1	Auto Comb select	Automatic input select Y/C-input and comb Y/C-input					

Table 3 The changing input system

SA07H D1	SA07H D0	Input system
0	0	CVBS1 system
0	1	CVBS2 system
1	0	CVBS3 system
1	1	Don't use.

Table 4 The changing input system and The changing TRAP

Selective		tate of detection			ut system	The chang	ging TRAP	
Mode	C-ID	Color System	Y	C	CVBS-out	C-TRAP	S-D TRAP	
Auto Y/C	Detected	4.43PAL, M/N-PAL, 3.58/4.43NTSC SECAM B/W	Y	C	Y + C	OFF	OFF	
Select	Not detected	4.43PAL, M/N-PAL, 3.58/4.43NTSC SECAM B/W	CVBS	CVBS	CVBS	ON	ON	
Auto Comb _ Select	Detected	4.43PAL, M/N-PAL, 3.58/4.43NTSC SECAM B/W	Y	C	Y + C	OFF	OFF	
	Not	4.43PAL, M/N-PAL, 3.58/4.43NTSC	Comb-Y	Comb-C	CVBS			
	detected	SECAM B/W	CVBS	CVBS	CVBS	ON OFF	ON OFF	

Table 5 The neglecting control items

Item	Content							
SA07H D2 (: VIDEO SELECT)	Monlooting							
SA05H D5 : C-TRAP	Neglecting date setting							
SA05H D6 : S-D TRAP	uate setting							

Note) Depending on the input signal state, this function may malfunction.

EXTERNAL INPUT SWs

External inputs are selected by the BUS data and fast SWs. Final outputs from pin 21/22/23 are shown in Table 6. RGB1-IN interface complies with SCART connector. Therefore it is active, when RGB1-IN is enable by the BUS data and when YS3(pin 15) is also high. The status of YS3(pin 15) is responded to the Read BUS data, V15.

	Table 6	Outputs from	m pin 21/22/2	23		
RGB SELECT	RGB1 ENB	YS3 (RGB1)	YS1 (YCbCR2)	YS2 (RGB2)	Output	
00	0	L H			Main (from V-SW)	
00	1	L H			RGB1	
01	0	L H	1	L	YCbCr1	
01	1	L H	L		RGB1	
10	0	L H			DCD1	
10	1	L H			RGB1	
11	_	_			_	
	_	_	Н		YCbCr2	
	_	_	L	Н	RGB2	
i e	I	1	TT			

RGB SELECT/RGB1 ENB: I2C BUS data, YS1/2/3: Fast SW

COLOR SYSTEM

Distinguishable color systems are selected by the write BUS data, COLOR SYSTEM. The demodulated color system is responded to the read BUS data, COLOR SYSTEM and X'TAL. (Refer to BUS CONTROL FUNCTION) The system data is also responded to Comb SYS(pin 45) and fsc-OUT(pin 46) as Table 7. If distinguishable color system signal is not received, the system data is responded with B/W.

Table 7 DC level of pin 45 and 46 on each color system

COLOR SYSTEM	Pin 45	Pin46
M-PAL	Low	Low
4.43PAL, SECAM,	High	Low
B/W		
3.58/4.43NTSC	Low	High
N-PAL	High	High

Besides, if pin 7 is connected to V_{CC}(more than 3.5V), Forced SECAM mode is active. In this mode, SECAM system is identified forcibly. It has priority over the BUS selection.

SECAM BELL FILTER

SECAM bell filter characteristics can be changed by the BUS data, BELL/HPF. The group delay near chroma band is corrected by changing filter characteristic. As a result, S/N looks better. Besides, center frequency f₀ of bell is changed by BELL f₀. Indirectly, it is changed by BPF(TOF) f₀.

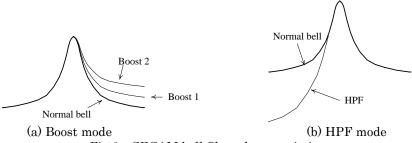


Fig.2 SECAM bell filter characteristics

VERTICAL COUNT-DOWN

In Automatic of V C/D MODE, the vertical synchronization is controlled by internal PLL. In Fast mode, it is synchronized with the inputted synchronizing signal and the pull-in time is short. Furthermore the time is shorter in Very fast mode by the expanded pull-in range. Pull-in range of vertical count-down is determined by the BUS data, V C/D MODE and V-FREQ as Table 8.

Table 8 V C/D pull-in range

	V C/D MODE	Normal 1, 2	Teletext	Fast
V FREQ		00, 11	01	10
000	Automatic 1	224-3	353H	32-353H
001	$50 \mathrm{Hz}$	274-3	353H	32-353H
010	60Hz	224-2	297H	32-297H
011	Automatic 2	224-3	353H	32-353H
100	312.5H	Forced 312	2.5H mode & AF	C free-run
101	262.5H	Forced 262	2.5H mode & AF	C free-run
110	313H	Forced 31	3H mode & AF	C free-run
111	263H	Forced 26	3H mode & AF	C free-run

- 00; Normal 1 Normal vertical input mode 1. It is good performance of vertical phase keeping for standard TV signal sync. And vertical output phase that is detected first time is kept always. And this mode can detect teletext or VCR skew sync (non-standard sync).
- O1; Teletext This mode is less performance of vertical phase keeping for standard TV signal sync against "Normal". However, pull-in speed is faster few vertical periods than "Normal". Therefore this mode is recommended for tesetext sync.

 On the other hand, this mode can detect standard TV signal sync in the state of stability but it is less performance of vertical phase keeping in week signal as about -3dB against "Normal".
- This mode is same performance of vertical phase keeping for standard TV signal sync of "Teletext". But it is faster pull-in speed faster than "Teletext" because pull-in ranges wider than "Teletext". (refer to Table 8)

 Therefore, this mode is better to use when channel changing, but is not recommended to use in the state of stability or in week signal due to too wide pull-in range and
- 11; Normal 2 Basic detecting function is same as "Normal 1". And in "Normal 1" mode, the vertical output phase that is detected first time is kept, however, in this mode, the vertical output phase is detected always.

incorrect actions of vertical keeping appearing.

Y-DL ADJUSTMENT

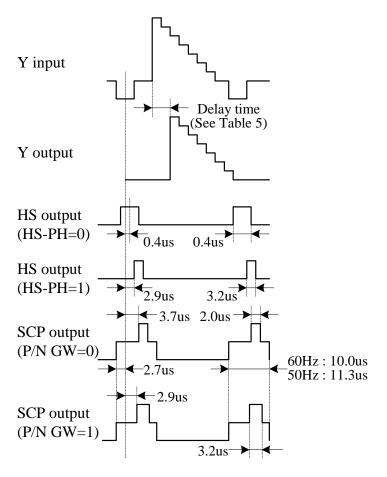
Table 9 shows Y output delays against Y input on condition with BPF= f_0 , Q=2.0, Y-DL=Min and LPF=ON. Y-out signal can be delayed by the BUS data, Y-DL. The adjustment time of one step is 40ns.

Table 9 Y delays according to the color system

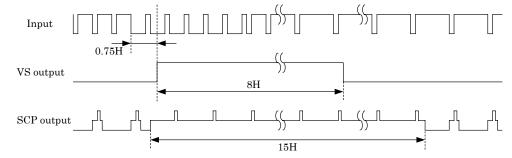
Color system	Y delay (ns)
PAL	450
NTSC	450
SECAM	650

PULSES TIMMING

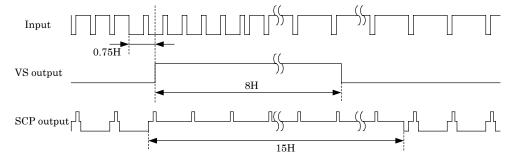
HORIZONTAL PERIOD (Typical output phase of horizontal pulses)



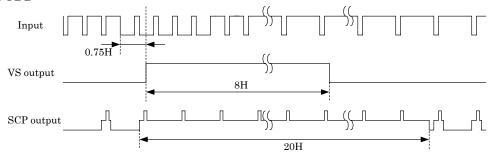
VERTICAL PERIOD (Typical output phase of vertical pulse) 60Hz ODD



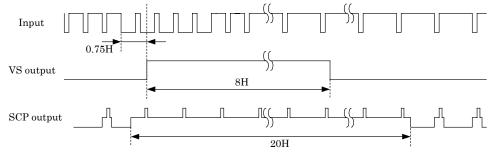
60 Hz EVEN



$50 \mathrm{Hz} \; \mathrm{ODD}$

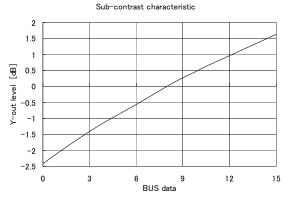


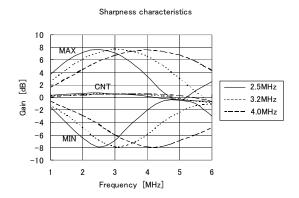
$50 \mathrm{Hz} \; \mathrm{EVEN}$



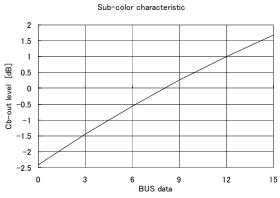
MISCELLANEOUS CHARACTERISTICS

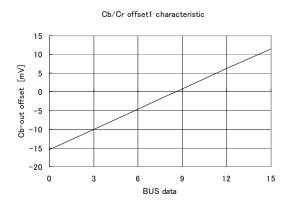
SHARPNESS=OFF, LPF=OFF. Other BUS data is preset, unless otherwise specially.



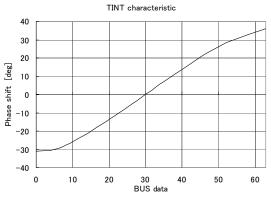


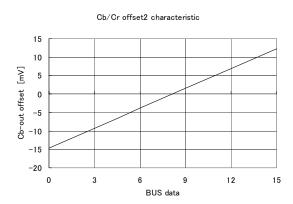
INPUT: RAMP 0.7Vp-p



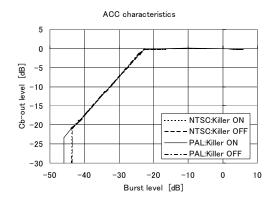


INPUT: 4.43PAL 75% color bar (CVBS1-IN)



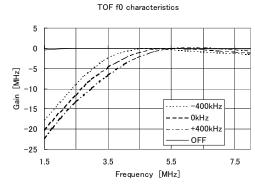


INPUT: 3.58NTSC rainbow color bar (CVBS1-IN)

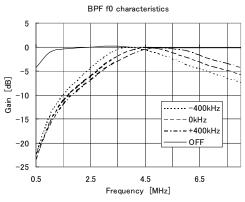


INPUT: 75% color bar

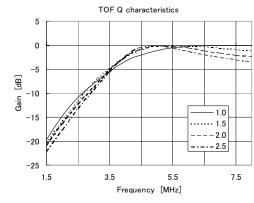
BUS : C-out level=12, Sub-color=0, BPF=f0, Q=1.5



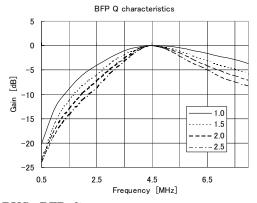
BUS : Q=1.5



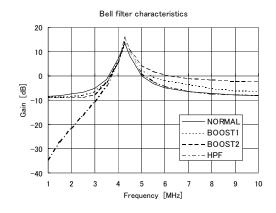
 $BUS:Q{=}1.5$

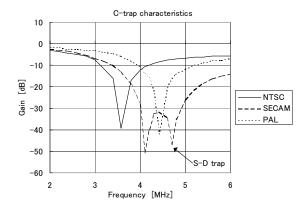


BUS: BPF=f0

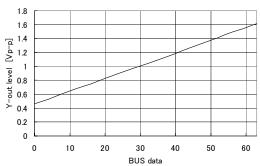


BUS: BFP=f0

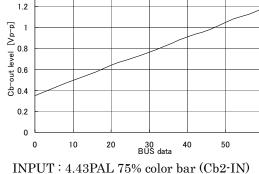




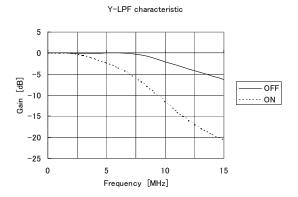
Y-out level characteristic



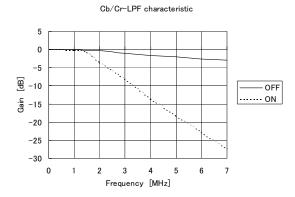
INPUT: RAMP 1.0Vp-p with sync(Y1-IN)



C-out level characteristic



INPUT: Y1-IN



INPUT: Cb1-IN

1.4

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MAXIMUM RATINGS (Ta=25°C)

ITEM	SYMBOL	RATING	UNIT
Supply voltage	V _{CC/DDmax}	5.5	V
Signal voltage at each input pin	einmax	5	Vp-p
Power consumption	P _D (Note1)	1644	mW
Power consumption reduction ratio	$1/~ heta_{ m ja}$	13.16	mW/℃
Operating temperature	$T_{ m opr}$	-20~65	$^{\circ}\!\mathbb{C}$
Storage temperature	$T_{ m stg}$	-55~150	$^{\circ}\!\mathbb{C}$

(Note1) Put on the circuit board. Refer to the figure below.

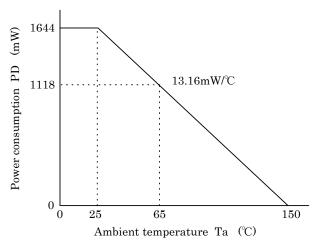


Fig. Power consumption reduction against ambient temperature.

(Note2)CAUTION

- 1. Since this device is susceptible to surge, handle with care. Especially, pin 39 is most weak to surge.
- 2. Confirm that pins connection is correct. Don't connect plus pins and minus pins to be opposite polarity. Refer to *Handling Guide* to handle ICs properly.
- 3. This device is not proof enough against a strong E-M field by CRT which may cause function errors and / or poor characteristics. Keeping the distance from CRT to the device longer than 20cm, or if cannot, placing shield metal over the device, is recommended in an application.
- 4. APC characteristics is sensitive to external conditions, please care floating capacitor by patterning and stray capacitor to X'tal.

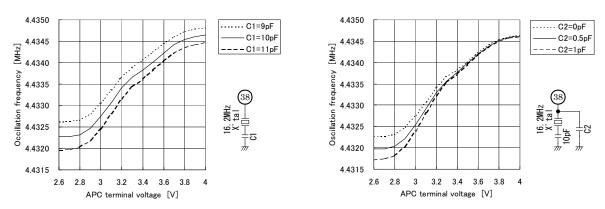


Fig. APC characteristics according to stray capacitor

SUPPLY VOLTAGE

ITEM	DESCRIPTION	MIN	TYP	MAX	UNIT
Supply voltage	Pin 6, 12, 32	4.75	5.0	5.25	V

ELECTRICAL CHARACTERISTICS

(YC-VCC/SYNC-VCC/D-VDD=5V and Ta=25 $^{\circ}$ C, unless otherwise specified)

CURRENT CONSUMPTION

PIN No.	PIN NAME	SYMBOL	MIN	TYP	MAX	UNIT
6	D VDD	$I_{ m DD}$	4	7	15	
12	SYNC VCC	I_{CC1}	9	13.5	20	mA
32	Y/C VCC	I_{CC2}	75	100	130	

AC CHARACTERISTICS

VIDEO SWITCH SECTION

ITEM	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNIT
Maximum video input range	Vdrvi	(NOTE V1)	1.4	_	_	Vp-p
CVBS-OUT amplitude gain	Gev	(NOTE V2)	_	6.0	_	dB
Frequency bandwidth	Gfv1	(NOTE V3)	_	12	_	MHz
Crosstalk between each input	CTvsw	(NOTE V4)	_	-55	_	dB
Y-OUT maximum output range	Vdryo		_	2.2	_	
Cb-OUT maximum output range	Vdrcbo	(NOTE V5)	_	2.2	_	Vp-p
Cr-OUT maximum output range	Vdrcro		_	2.2	_	

LUMINANCE SECTION

ITEM		SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNIT
	3.58MHz	Gtr3		25	36	_	
Chromo trop attenuation	4.43MHz	Gtr4	(NOTE Y1)	25	36	ı	dB
Chroma trap attenuation	SECAM	GtrS	(NOTE 11)	25	36	ı	αΒ
	S double	GtrSD		25	36	1	
Y S/N ratio		Ysn	Trap off	1	60	1	
	MAIN	Offs1MAIN		-5	_	5	
Cb/Cr offset level 1	YCbCr1	Offs1YCbC r1	(NOTE Y2)	-5	_	5	mV
RGB1		Offs1RGB1		-5	_	5	
Cb/Cr offset level 2		Offs2	(NOTE Y3)	-5	_	5	
Black set-up		BSETUP	_	180	200	220	mV

CHROMA SECTION

ITEM		SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNIT
TINT center		T θ 3NCT	3N,CNT	-10	0	10	deg
APC pull-in range (4.43MHz	z PAL)	APCp	(NOTE C1)	-400	_	400	Hz
	3N,NORMAL ON→OFF	KilNNoff		1	-42.5	1	
Killer operation input level	3N,LOW, ON→OFF	KilNLoff	(NOTE C2)	1	-38		dB
Killer operation input level	4P,NORMAL, ON→OFF	KilPNoff	(NOTE C2)	ı	-45		uБ
	4P,LOW, ON→OFF	KilPLoff		1	-40.5	1	
Demodulated Cb and Cr out		ldNTSC	$Cr_{(x)}/Cr_{(PAL)}$	-1.5	0	1.5	dB
Difference (PAL 75% color	ber)	ldSECAM	Cb(x)/Cb(PAL)	-1.5	0	1.5	dB
		V3Nbr	PAL : Cr/Cb	-1	_	1	
Demodulation relative ampl	itude (Cb/Cr)	V4Nbr	NTSC : Cr/Cb	-1	_	1	dB
		V4Pbr	SECAM : Cr/Cb	-1	_	1	
		ldYCbCr1		-2	_	2	
Cb and Cr output level diffe	rence	ldRGB1	$\operatorname{Cr}_{(x)}/\operatorname{Cr}_{(PAL)}$	-2	_	2	dB
(PAL 75% color ber)		ldYCbCr2	$Cb_{(x)}/Cb_{(PAL)}$	-2	_	2	αь
		ldRGB2		-2	_	2	
Demodulation output residual carrier		ResiCarr	(NOTE C3)	_	_	20	mVp-p
Demodulation output residual higher harmonic		ResiHarm	(NOTE C4)	_	_	40	mVp-p
fsc free-run frequency	3.58N 4.43P	3fr 4fr	(NOTE C5)		$\frac{3579640}{4433700}$		Hz

SECAM SECTION

320121 52011011							
ITEM		SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNIT
SECAM black level adjustment	Cb,CNT	SBCbCT	_	-9	_	9	
SECAM black level adjustment	Cr,CNT	SBCrCT	_	-9	_	9	
Linearity		LinCb	(NOTE S1)	l	100	l	%
Linearity		LinCr	(NOTE SI)	ı	100	l	70
Transient characteristic		trCb	(NOTE S2)	_	0.8	_	0
Transient characteristic		trCr	(NOTE 52)	ı	1.2	ı	μ s
Killer operation input level VID OF		eSK	(NOTE S3)		-42		dB
Killer operation input level	VID OFF	eSC (NOTE S3)			-39		ub
1H DL gain ratio between direct	gDL	_	_	_	5	%	

SYNCHRONIZING SECTION

ITEM		SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNIT
HS output start voltage		VSHVCO	Vcc voltage	_	3.6	_	V
UC output frequency	50Hz	fHD50	_	15.4	15.625	15.9	kHz
HS output frequency	60Hz	fHD60	_	15.4	15.734	15.9	KIIZ
H AFC pull-in range	50Hz	AFCp50	_	14.625	15.625	16.625	kHz
If AFC pull in range	60Hz	AFCp60		14.734	15.734	16.734	
H AFC hold range	50Hz	AFCh50		14.625	15.625	16.625	kHz
If AFC floid range	60Hz	AFCh60		14.734	15.734	16.734	

TEST CONDITION (Unless otherwise specified, YC-VCC/SYNC-VCC/D-VDD=5V and Ta= $25\pm3^{\circ}$ C)

NOTE	ITEM	MEASURING METHOD
		COMMON TEST CONDITION ① Unless otherwise specified, Y/C VCC, Sync-VCC and Digital VDD=5V, Ta=25±3°C. ② Set the BUS data preset, unless otherwise specified. ③ Unless otherwise specified, SW33/34/35/39/41=A, ADD SW=B, Y1 SW=A, SYNC SW=A.
	VIDEO SWITCH SECTION	COMMON TEST CONDITION FOR LUMINANCE SECTION ① Set the BUS data as Sharpness fo is.
V1	Maximum video input range	① Set the BUS data as CVBS1 input is selected. ② Minimize Y-OUT LEVEL via I ² C BUS. ③ Input ramp-signal to CVBS1/Y1-IN(pin 1). ④ Measure input range on the right figure at pin21(Y-OUT).
		Output
V2	CVBS-OUT amplitude gain	 Set the BUS data as CVBS1 input is selected. Input video signal (1.0Vp-p) to CVBS1/Y1-IN(pin 1). Calculate the gain between input signal's amplitude and amplitude of CVBS-OUT(pin 3).
V3	Frequency bandwidth	 Set the BUS data as CVBS1 input is selected. Input sweep-signal to pin 1(CVBS1/Y1-IN). Measure the frequency where the ratio between the amplitude of pin 3(CVBS-OUT) and that of pin 1(CVBS1/Y1-IN) is -3dB by network analyzer.
V4	Crosstalk between each input	 ① Input Signal 1(f₀=4MHz, V₀=0.7V, V_S=0V) to pin 1(CVBS1/Y1-IN). ② Set the BUS data as CVBS1 input is selected. ③ Short other input pins with AC coupling. Measure the amplitude of pin 3(CVBS-OUT). (V1) ④ Set the BUS data as CVBS2 input is selected via I²C BUS. ⑤ Measure the amplitude of pin 3(CVBS-OUT). (V2) ⑥ Crosstalk level from pin 1 to pin 3 is calculated by the following equation.
V5	Y-OUT maximum output range Cb-OUT maximum output range Cr-OUT maximum output range	 Set the BUS data as CVBS1 input is selected. Maximize Y-OUT LEVEL via I²C BUS. Measure Y output range at Y-OUT(pin 21) in the same as NOTE V1. Measure Cb/Cr output range as well.

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NOTE	ITEM	MEASURING METHOD
	LUMINANCE SECTION	COMMON TEST CONDITION FOR LUMINANCE SECTION
		① Set the BUS data as Y1/C1 input is selected.
Y1	Chroma trap attenuation	① Set the BUS data as C TRAP is ON.
		② Input signal $1(f_0=3.58\text{MHz}(\text{NTSC}), V_0=0.5\text{V}, V_S=0\text{V})$ to pin $1(\text{CVBS1/Y1-IN})$.
		③ Measure the amplitude at pin 21(Y-OUT) with the chroma trap being turned on(VTon) and off(VToff).
		Calculate the attenuation value as following equation.
		Gtr3=20log(VToff / VTon)
		④ Calculate the following value in the same way as② to ③.
		$Gtr4: f_0=4.43MHz(PAL)$
		$GtrS: f_0=4.43MHz(SECAM)$
		$GtrSD : f_0=5.0MHz(SECAM, S-D TRAP = ON)$
Y2	Cb, Cr offset level 1	① Input PAL Black Burst signal to pin 1(CVBS1/Y1-IN).
		② Monitor Cb or Cr out (pin 22 or 23), and measure voltage between blanking period and picture period as
		Offs1MAIN.
		③ Set the BUS data as RGB SELECT is YcbCr1 (or RGB1), and measure Offs1YcbCr1(or OffsRGB1) in the
		same way as ②.
Y3	Cb, Cr offset level 2	① Set YS1(pin 24)=2V and Cb2, Cr2-in: no-signal input.
		② Monitor Cb or Cr-OUT(pin 22 or 23), and measure voltage between blanking period and picture period as
		Offs2.

TOSHIBA

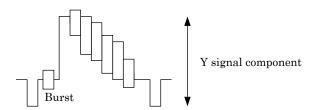
NOTE	ITEM	MEASURING METHOD
	CHROMA SECTION	COMMON TEST CONDITION FOR CHROMA SECTION ① Set the BUS data as Y1/C1 input is selected via I ² C BUS. ② Set the BUS data as BPF f ₀ is through, Color system is Europe mode and P/N GW is 2.0 μ s.
C1	APC pull-in/hold range	 Input color signal(4.43PAL, 100mVp-p) to pin 48(C1-IN). Increase its frequency until Cb-OUT at pin 22 is discolored(upper hold range), and decrease its frequency until Cb-OUT is colored(upper pull-in range). In the same way, decrease its frequency until Cb-OUT is discolored(lower hold range), and increase its frequency until Cb-OUT is colored(lower pull-in range). Calculate the differences between the frequencies and center frequency(4.43MHz).
C2	Killer operation input level	① Set the BUS data as P/N ID is Normal. ② Input color signal(3.58NTSC) to pin 48(C1-IN). ③ While attenuating the burst signal, measure the burst amplitude when Cb-OUT(pin 22) is discolored. ④ Set P/N ID Low, and measure killer level as well. ⑤ Input 4.43PAL color signal to pin 48, and measure items in the same way as①to④.
СЗ	Demodulation output residual carrier	 Input 3.58NTSC or 4.43NTSC rainbow color bar signal(burst=100mVp·p) to pin 48(C1-IN). Measure sub-carrier leak's amplitude in Cb signal of pin 22 and Cr signal of pin 23 respectively.
C4	Demodulation output residual higher harmonic	 Input 3.58NTSC or 4.43NTSC rainbow color bar signal(burst=100mVp-p) to pin 48(C1-IN). Measure higher harmonic's amplitude (2fc=7.16MHz or 8.86MHz) in Cb signal of pin 22 and Cr signal of pin 23 respectively.
C5	fsc free-run frequency	 Input nothing into pin 48(C1-IN). Change setting of Color system according to respective frequency modes. Measure frequency of fsc signal of pin 46 respectively.

TOSHIBA

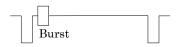
NOTE	ITEM	MEASURING METHOD
	SECAM SECTION	COMMON TEST CONDITION FOR SECAM SECTION
		① Set the BUS data as Y1/C1 input is selected.
		② Input SECAM 75% color bar(R-Y ID=214mVp-p) to pin 48(C1-IN), unless otherwise specified.
S1	Linearity	① Measure the amplitude from black bar levels in output of pin 22 and 23.
		② Calculate items by the following equation.
		LinCb= V[yellow] / V[blue] × 100 (%)
		LinCr= V[cyan] / V[red] × 100 (%)
S2	Transient characteristic	① Measure the period shown in the following figure at pin 22(Cb-OUT) and pin 23(Cr-OUT). Green **TRCb, tTRCr** 90% Magenta
S3	Killer operation input level	 Set the BUS data as S-ID is Normal and S V-ID SW is OFF. While attenuating the ID signal, measure its R-Y ID amplitude when the killer is ON/OFF as eSK and eSC.

TEST SIGNAL

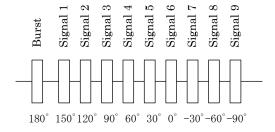
Color bar



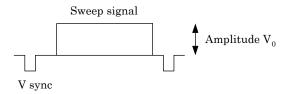
Black Burst



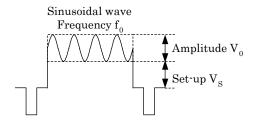
Rainbow color bar



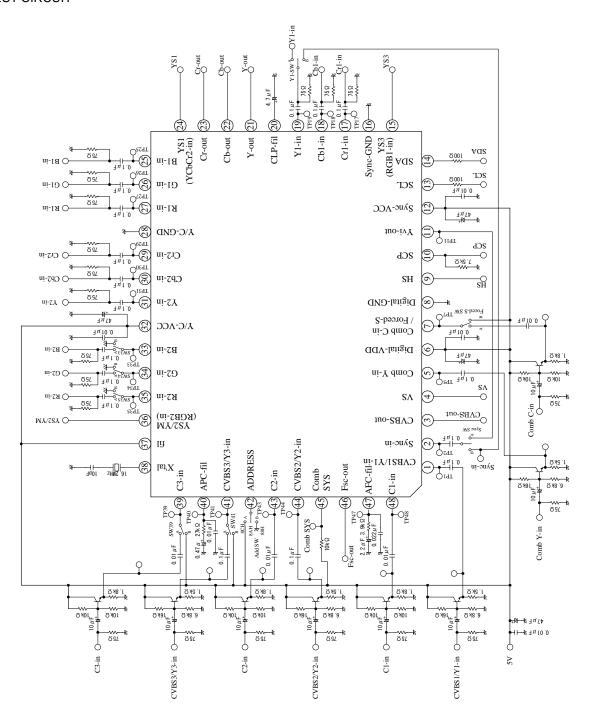
Sweep signal



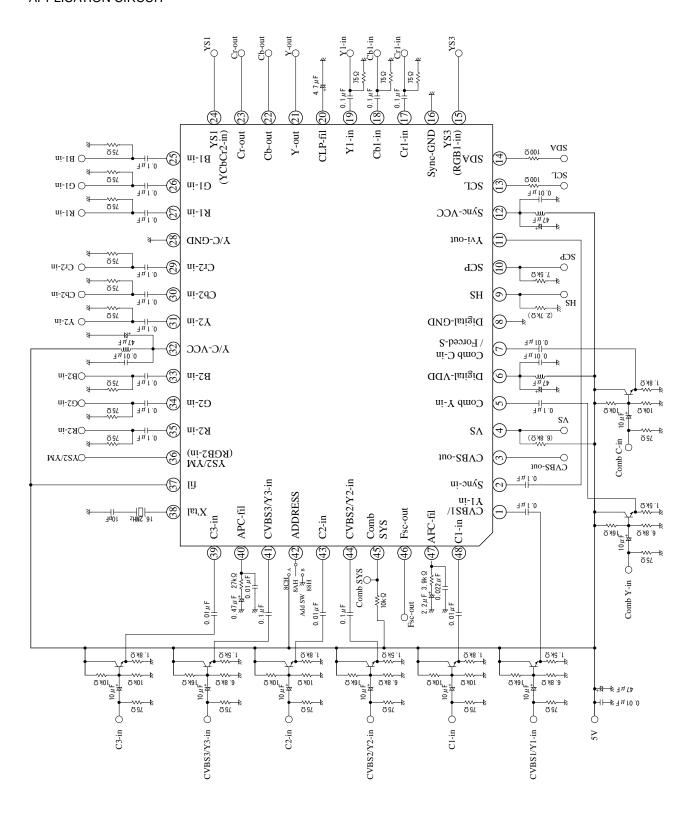
Signal 1



TEST CIRCUIT



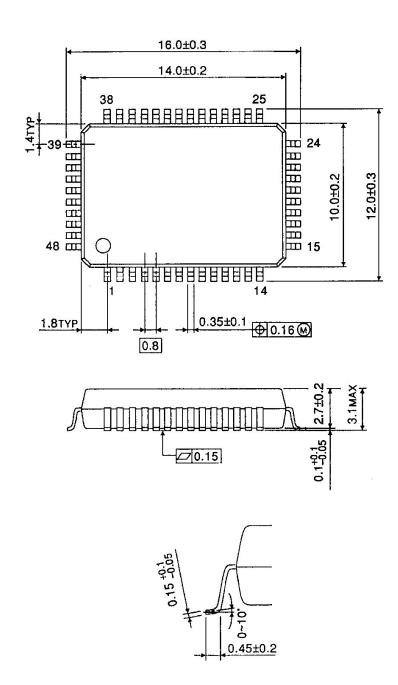
APPLICATION CIRCUIT



OUTLINE DRAWING

QFP48--P-1014-0.80

Unit:mm



Weight: 0.83 g (Typ.)

About solderability, following conditions were confirmed

- Solderability
 - (1) Use of Sn-63Pb solder Bath
 - · solder bath temperature = 230°C
 - · dipping time = 5 seconds
 - · the number of times = once
 - · use of R-type flux
 - (2) Use of Sn-3.0Ag-0.5Cu solder Bath
 - · solder bath temperature = 245°C
 - · dipping time = 5 seconds
 - · the number of times = once
 - · use of R-type flux

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030619EBA

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